

# 100 VOLTS PDK

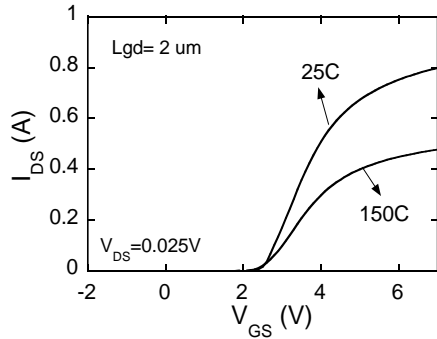
## 40V transistor

Key electrical parameters of a **40V** e-Mode p-GaN HEMT power device ( $W_{\text{eff}}=120$  mm)

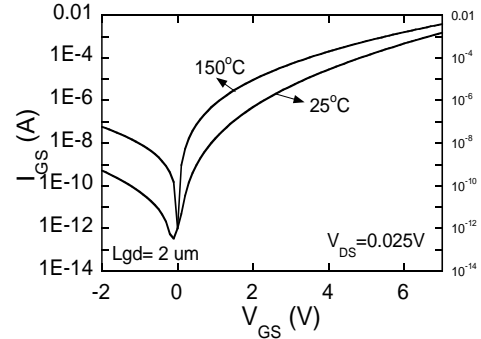
Symbol	Description	Test Conditions	Min	Typ	Max	Unit
<b>Absolute Maximum Ratings</b>						
$BV_{DS}$	Drain-Source voltage			40		V
$I_D$	Pulsed Drain current	1 ms pulse			24	A
$V_{GS}$	Gate-Source voltage		-10		7	V
<b>ON/OFF-State Characteristics</b>						
$BV_{DS}$	Drain-Source voltage	$V_{GS} = 0$ V	40			V
$I_{DSS}$	Drain-Source leakage	$V_{GS} = 0$ V, $V_{DS} = 40$ V $T=25^\circ\text{C}$		300	<1000	nA/mm
	Drain-Source leakage	$V_{GS} = 0$ V, $V_{DS} = 40$ V $T=150^\circ\text{C}$		10	<100	$\mu\text{A/mm}$
$I_{GSS}$	Gate forward leakage	$V_{GS} = 7$ V, $V_{DS} = 0$ V $T=25^\circ\text{C}$		13	<100	$\mu\text{A/mm}$
$R_{DS-ON}$	Drain-Source ON resistance	$V_{GS} = 7$ V, $V_{DS} = 0.1$ V $T=25^\circ\text{C}$		2.8	5.5	$\Omega\cdot\text{mm}$
	Drain-Source ON resistance	$V_{GS} = 7$ V, $V_{DS} = 0.1$ V $T=150^\circ\text{C}$		5.3	8.8	
$V_{TH}$	Gate threshold voltage	Maximum $g_m$	2.1	2.5	2.9	V
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input capacitance	$V_{GS} = 0$ V $V_{DS} = 20$ V $f = 100$ kHz		0.52		pF/mm
$C_{OSS}$	Output capacitance			0.69		pF/mm
$C_{RSS}$	Reverse transfer capacitance			62		pF/mm
Dispersion	Dynamic $R_{ON}$ (normalized)	$T=25^\circ\text{C}$ till $150^\circ\text{C}$ , 0–100 Volt range, Pulsed 10 $\mu\text{s}$ ON - 1990 $\mu\text{s}$ OFF			<25	%

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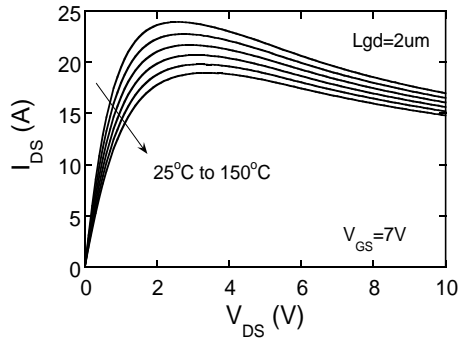
## 40V transistor



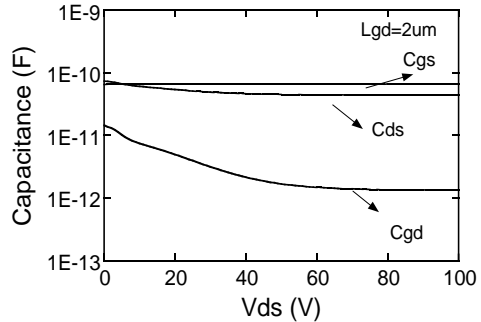
Typical transfer IV curve and transconductance at  $V_{DS}=0.1V$



Typical gate leakage IV curve at  $T=25^\circ C$



Typical output IV curves at  $V_{GS}=7V$  at  $T=25^\circ C$  to  $150^\circ C$  with  $25^\circ C$  step



Typical off-state capacitance of device at  $V_{GS}=0$

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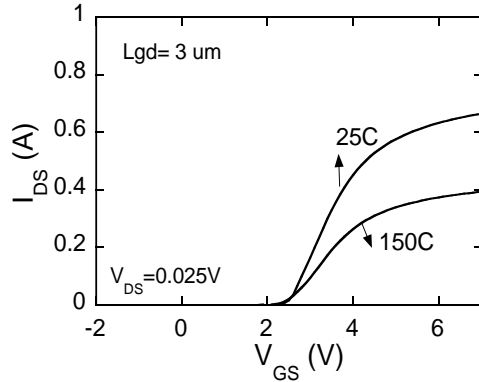
## 100V transistor

Key electrical parameters of a **100V** e-Mode p-GaN HEMT power device ( $W_{\text{eff}}=120 \text{ mm}$ )

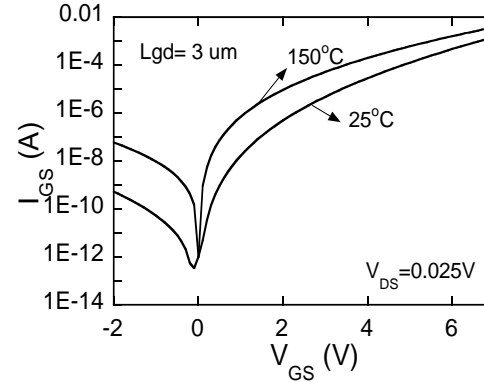
Symbol	Description	Test Conditions	Min	Typ	Max	Unit
<b>Absolute Maximum Ratings</b>						
$BV_{DS}$	Drain-Source voltage			100		V
$I_D$	Pulsed Drain current	1 ms pulse			23	A
$V_{GS}$	Gate-Source voltage		-10		7	V
<b>ON/OFF-State Characteristics</b>						
$BV_{DS}$	Drain-Source voltage	$V_{GS} = 0 \text{ V}$	100			V
$I_{DSS}$	Drain-Source leakage	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}$ $T=25^\circ \text{ C}$		300	<1000	nA/mm
	Drain-Source leakage	$V_{GS} = 0 \text{ V}, V_{DS} = 100$ $T=150^\circ \text{ C}$		10	<100	$\mu\text{A/mm}$
$I_{GSS}$	Gate forward leakage	$V_{GS} = 7 \text{ V}, V_{DS} = 0 \text{ V}$ $T=25^\circ \text{ C}$		13	<100	$\mu\text{A/mm}$
$R_{DS-ON}$	Drain-Source ON resistance	$V_{GS} = 7 \text{ V}, V_{DS} = 0.1 \text{ V}$ $T=25^\circ \text{ C}$		3.5	6	$\Omega\cdot\text{mm}$
	Drain-Source ON resistance	$V_{GS} = 7 \text{ V}, V_{DS} = 0.1 \text{ V}$ $T=150^\circ \text{ C}$		6.8	10	
$V_{TH}$	Gate threshold voltage	Maximum $g_m$	2.1	2.5	2.9	V
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input capacitance	$V_{GS} = 0 \text{ V}$ $V_{DS} = 100 \text{ V}$ $f = 100 \text{ kHz}$		0.52		pF/mm
$C_{OSS}$	Output capacitance			0.61		pF/mm
$C_{RSS}$	Reverse transfer capacitance			30		pF/mm
Dispersion	Dynamic $R_{ON}$ (normalized)	$T=25^\circ \text{ C}$ till $150^\circ \text{ C}$ , 0–100 Volt range, pulsed 10 $\mu\text{s}$ ON - 1990 $\mu\text{s}$ OFF			<25	%

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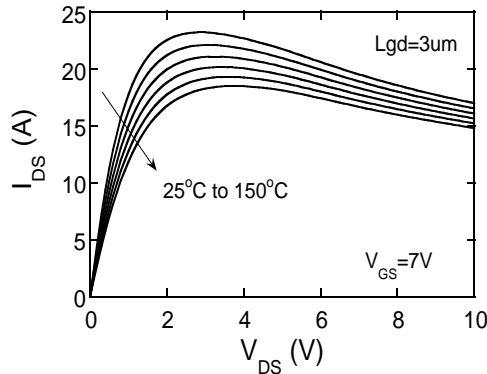
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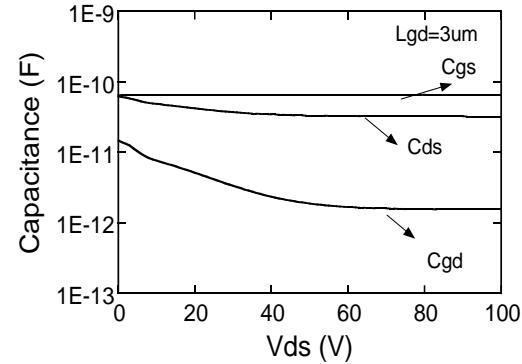
Typical transfer IV curve and transconductance at  $V_{DS}=0.1\text{V}$



Typical gate leakage IV curve at  $T=25^\circ\text{C}$



Typical output IV curves at  $V_{GS}=7\text{V}$  at  $T=25^\circ\text{C}$  to  $150^\circ\text{C}$  with  $25^\circ\text{C}$  step



Typical off-state capacitance of device at  $V_{GS}=0$